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N-Channel Power Trench[®] MOSFET 25 V,60 A, 5.8 m Ω

Features

- Max $r_{DS(on)}$ = 5.8 m Ω at V_{GS} = 10 V, I_D = 17 A
- Max $r_{DS(on)}$ = 8 m Ω at V_{GS} = 4.5 V, I_D = 14 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

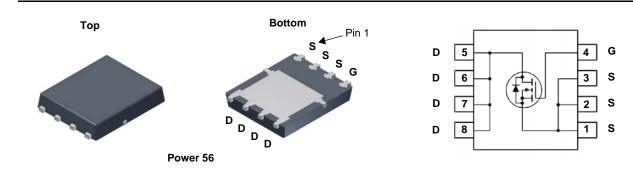


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- Control MOSFET for Synchronous Buck Converters
- Notebook
- Server
- Telecomm
- High Efficiency DC-DC Switch Mode Power Supplies



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Param	Ratings	Units		
V _{DS}	Drain to Source Voltage			25	V
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V
	Drain Current -Continuous	T _C = 25 °C		60	
I _D	-Continuous	T _A = 25 °C	(Note 1a)	17	Α
	-Pulsed		(Note5)	90	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	40	mJ
D	Power Dissipation	T _C = 25 °C		33	14/
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		3.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7578	FDMS7578	Power 56	13 "	12 mm	3000 units

FDMS7578
N-Channel
Power ⁻
Trench®
[®] MOSFET

Units

Max

Off Char	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{\rm D} = 250 \ \mu {\rm A}, \ {\rm V}_{\rm GS} = 0 \ {\rm V}$ 25				V
∆BV _{DSS} <u>∆Tj</u>	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		20		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
GSS	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
On Char	acteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.6	3.0	V
ΔV _{GS(th)} _ΔT_j	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 17 A		4.6	5.8	mΩ
	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 14 A		6.3	8	
		$V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 17 \text{ A}, \ \text{T}_{J} = 125 \ ^{\circ}\text{C}$		6.7	8.5	
9 _{FS}	Forward Transconductance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 17 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$ $V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$		6.7 77	8.5	S
Dynamic	Characteristics			77		
)ynamic C _{iss}	Characteristics	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$		77	1625	pF
Dynamic D _{iss} D _{oss}	Characteristics Input Capacitance Output Capacitance			77 1221 371	1625 495	pF pF
Dynamic C _{iss} C _{oss} C _{rss}	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		77 1221 371 54	1625	pF
	Characteristics Input Capacitance Output Capacitance	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		77 1221 371	1625 495	pF pF
Dynamic D _{iss} D _{oss} D _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		77 1221 371 54	1625 495 85	pF pF pF
ynamic Piss Poss Prss Rg Witchin	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		77 1221 371 54	1625 495 85	pF pF pF
Dynamic Dysamic Diss Diss Diss Rg Switchin d(on)	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Characteristics	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz		77 1221 371 54 1.2	1625 495 85 2.4	pF pF pF Ω
Dynamic Diss Coss Drss Rg Switchin d(on) r	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Ig Characteristics Turn-On Delay Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		77 1221 371 54 1.2 8	1625 495 85 2.4 17	pF pF pF Ω
Dynamic Diss Coss Crss Rg Switchin d(on) r d(off)	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Gate Resistance Turn-On Delay Time Rise Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 13 \text{ V}, \text{ I}_{D} = 17 \text{ A},$		77 1221 371 54 1.2 8 2.6	1625 495 85 2.4 17 10	pF pF pF Ω ns
Dynamic Diss Coss Crss Rg Switchin d(on) r d(off) f	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Gate Resistance Turn-On Delay Time Rise Time Turn-Off Delay Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ f = 1 MHz $V_{DD} = 13 \text{ V}, \text{ I}_{D} = 17 \text{ A},$		77 1221 371 54 1.2 8 2.6 20	1625 495 85 2.4 17 10 33	pF pF pF Ω ns ns
Dynamic D _{iss} C _{oss} C _{rss} Rg Switchin d(on) r d(off) f	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Gate Resistance Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		77 1221 371 54 1.2 8 2.6 20 2.2	1625 495 85 2.4 17 10 33 10	pF pF pF Ω ns ns ns ns
Dynamic C _{iss} C _{oss} C _{rss} R _g	Characteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Gate Resistance Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$ $V_{DS} = 13 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$ $V_{DD} = 13 \text{ V}, \text{ I}_{D} = 17 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$		77 1221 371 54 1.2 8 2.6 20 2.2 18	1625 495 85 2.4 17 10 33 10 25	pF pF pF Ω ns ns ns ns ns nc

Test Conditions

Min

Тур

Drain-Source Diode Characteristics

Electrical Characteristics T_J = 25 °C unless otherwise noted

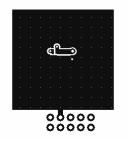
Parameter

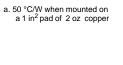
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	0.72	1.1	V
	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 17 A$	(Note 2)	0.83	1.2	v
t _{rr}	Reverse Recovery Time			20	32	ns
Q _{rr}	Reverse Recovery Charge	I _F = 17 A, di/dt = 100 A/μs		6	12	nC
t _{rr}	Reverse Recovery Time	1 17 A di/dt 200 A/va	19	34	ns	
Q _{rr}	Reverse Recovery Charge	I _F = 17 A, di/dt = 300 A/μs		13	24	nC

NOTES:

Symbol

1. $R_{0,LG}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{0,LC}$ is guaranteed by design while $R_{0,CA}$ is determined by the user's board design.



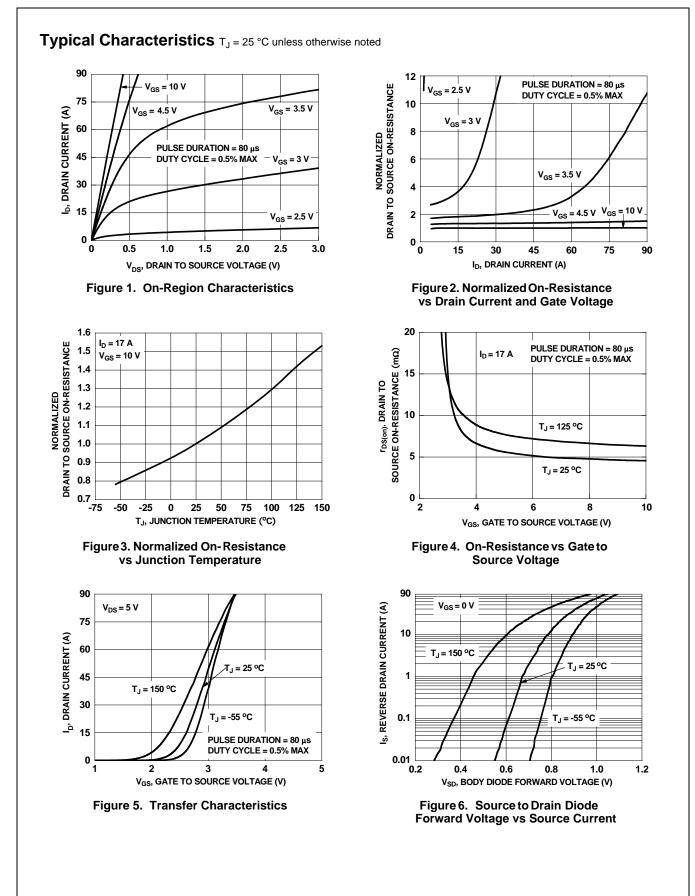


b.125 °C/W when mounted on a minimum pad of 2 oz copper

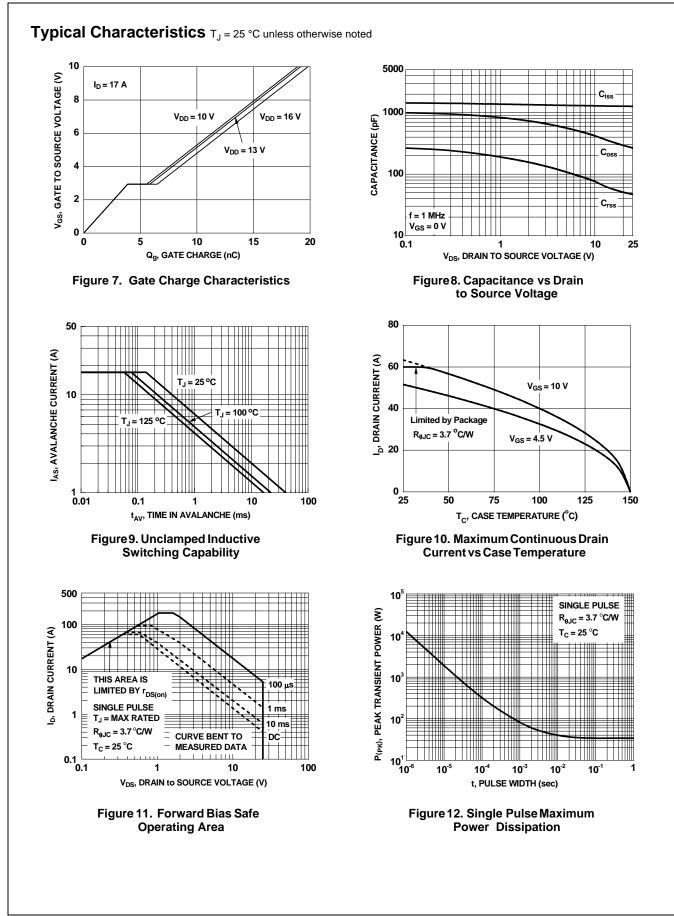


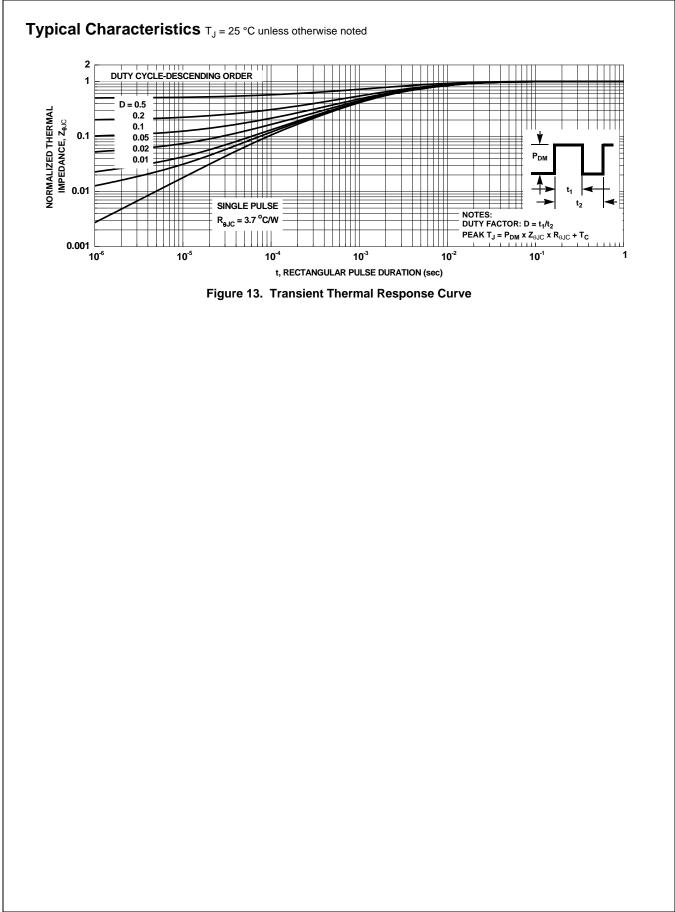
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

- 3. E_{AS} of 40 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 9 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 14 A.
- 4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.
- 5. Pulse Id refers to Figure.11 Forward Bias Safe Operation Area.











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